To Study the Effect of Different Substrate Materials on Rectangular Microstrip Patch Antenna Parameters Using HFSS

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Abstract
The study of microstrip patch antennas has made great progress in recent years. Compared with conventional antennas, microstrip patch antennas have more advantages and better prospects. They are lighter in weight, low volume, low cost, low profile, smaller in dimension and ease of fabrication and conformity. Moreover, the microstrip patch antennas can provide dual and circular polarizations, dual-frequency operation, frequency agility, broad band-width, feedline flexibility, beam scanning omnidirectional patterning. In this paper we will discuss the effect of different substrate materials on rectangular microstrip patch antenna parameters at 6.6 GHz. Rectangular MPA is simulated using HFSS which is based on FEM.

1. INTRODUCTION
There are several parameters when considering high frequency laminate materials which have low dielectric constant (Dk). They are related to reliability, directivity, gain, radiated power, accepted power, radiation efficiency, manufacturability and good predictable electrical performance. The RT/duroid 5000 family of high performance laminates offers low Dk laminates with very low Dr. A recent addition, RT/duroid 5880 LZ laminate, has the lowest Dk and offers several improvements to most other PTFE laminates[8].

Polytetrafluoroethylene (PTFE) based substrates are used to provide a laminate with a Dk(dielectric constant) that is relatively low (< 2.5). The RT/duroid 5870 and 5880 are low loss laminates that have been in use. While both have a relatively high percentage of PTFE, the addition of a small amount of filler and some special processing reduces the x-y axis CTE to the range of 40 ppm/ºC (from the 300 ppm/ºC of pure PTFE). Keeping the x-y axis CTE relatively low and near the CTE of copper (17 ppm/ºC) is beneficial for reliability. Even though the CTE is higher in the z-axis (thickness) direction (173ppm/ºC and 237ppm/ºC for the 5870 and 5880, respectively), these materials have been used in numerous high reliability applications for many years. In general, a simpler printed circuit board (PCB) construction, such as a microstrip, minimizes reliability concerns. Again, keeping the material thinner is beneficial and making a hybrid construction using very low CTE materials with the RT/duroid 5000 laminate will minimize any reliability concerns.

The RT/duroid family of products offers several laminates with a low Dk. The RT/duroid 5000 family of products has the lowest Dk values on the market today as well as stringent control of this property. The CTE issue associated with PTFE based laminates can be overcome by the use of a thinner laminate and multilayers using hybrid constructions. The low density of the 5880LZ can be very beneficial to applications where weight is restricted [8].

With an extensive line of products, the RT/duroid® product line has been used in a wide-range of applications for many decades.

2. MICROSTRIP PATCH ANTENNA
A microstrip patch antenna (MPA) consists of a conducting patch of any planar or nonplanar geometry on one side of a dielectric substrate with a ground plane on other side[1]. It is a popular printed resonant antenna for narrow-band microwave wireless links that require semi- hemispherical coverage. Due to its planar configuration and ease of integration with microstrip technology, the microstrip patch antenna has been heavily studied [9].

3. FINITE ELEMENT METHOD (FEM)
Finite Element Method (FEM). The basic approach of this method is to divide a complex structure into smaller sections of finite dimensions known as elements. These elements are connected to each other via joints called nodes. Each unique element is then solved independently of the others thereby drastically reducing the solution complexity. The final solution is
then computed by reconnecting all the elements and combining their solutions. These processes are named assembly and solution respectively in the FEM [6].

4. PROPOSED ANTENNA PARAMETERS AND DESIGN

Rectangular Microstrip with the following dimensions is designed using HFSS resonating at 6.6 Ghz and then results are obtained using different substrate materials [3].

Fig 2: Top View

Fig 3: Cross View

The different substrate materials used in the proposed antenna are Rogers RT/ Duroid 5880(tm), Epoxy_kevlar, FR4_Epoxy, Polyester. The below table shows the different substrate materials used with their relative permeability and relative permittivity.

Table 1: Substrate materials Used

<table>
<thead>
<tr>
<th>Material</th>
<th>Relative Permittivity</th>
<th>Relative Permeability</th>
</tr>
</thead>
<tbody>
<tr>
<td>Rogers RT/ Duroid 5880(tm)</td>
<td>2.2</td>
<td>1</td>
</tr>
<tr>
<td>Epoxy_kevlar</td>
<td>3.6</td>
<td>1</td>
</tr>
<tr>
<td>FR4_Epoxy</td>
<td>4.4</td>
<td>1</td>
</tr>
<tr>
<td>Polyester</td>
<td>3.2</td>
<td>1</td>
</tr>
</tbody>
</table>

5. RESULTS AND DISCUSSION

The microstrip patch antenna parameters such as peak directivity , peak gain , peak realized gain , radiated power, accepted power, incident power , radiation efficiency and radiation patterns using 3D polar plot are analysed using different substrate materials.

6. Antenna parameters for Rectangular MPA using Epoxy kevlar substrate

The below figure shows the antenna parameters for rectangular MPA using epoxy Kevlar substrate.

Fig 4: The Rectangular MPA resonates at a frequency of 6.6 Ghz.

7. Antenna parameters for Rectangular MPA using Polyester substrate

The below figure shows the antenna parameters for rectangular MPA using polyester substrate.

Fig 5: Parameters using Epoxy Kevlar Substrate

Fig 6: Parameters using polyester substrate
8. Antenna parameters for Rectangular MPA using FR4_Epoxy substrate  
The following figure shows antenna parameters for rectangular MPA using FR4 epoxy substrate.

<table>
<thead>
<tr>
<th>Antenna Parameters</th>
<th>Quantity</th>
<th>Value</th>
<th>Units</th>
</tr>
</thead>
<tbody>
<tr>
<td>Max</td>
<td>0.35254</td>
<td>W/μ</td>
<td></td>
</tr>
<tr>
<td>Peak Directivity</td>
<td>1.181</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Peak Gain</td>
<td>1.422</td>
<td></td>
<td></td>
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<tr>
<td>Peak Reflected Gain</td>
<td>0.81116</td>
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</tr>
<tr>
<td>Radiated Power</td>
<td>0.52389</td>
<td>W</td>
<td></td>
</tr>
<tr>
<td>Absorbed Power</td>
<td>0.47627</td>
<td>W</td>
<td></td>
</tr>
<tr>
<td>Radiated Power</td>
<td>0.5</td>
<td>W</td>
<td></td>
</tr>
<tr>
<td>Radiation Efficiency</td>
<td>0.87728</td>
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</tr>
<tr>
<td>Front to Back Ratio</td>
<td>N/A</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Decay Factor</td>
<td>0</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

Fig 7: Parameters using FR4 epoxy substrate

9. Antenna parameters for Rectangular MPA using Rogers RT/Duroid 5880(tm) substrate  
The following figure shows antenna parameters for rectangular MPA using rogers RT/Duroid 5880(tm) substrate.

10. CONCLUSION  
A rectangular microstrip patch antenna is studied, designed and simulated and antenna parameters & radiation patterns with different substrate materials are compared. Rectangular MPA using Rogers RT/Duroid 5880(tm)substrate gives the best results with peak directivity of 3.237, peak gain of 3.1837, peak realized gain of 1.7519, radiated power of 0.54123 W, accepted power of 0.55029 W, incident power of 1, radiation efficiency of 0.98353 and resonates at 6.6 GHz making it suitable for C band applications. Such type of antenna is useful for Telecommunication, Wi-fi, Radar, Satellite communication, Military communication and commercial.

11. REFERENCES  